

**Dynamical Ag⁺-Intercalation with AgSnSe₂ Nano-Precipitates in Cl-Doped Polycrystalline
SnSe₂ toward Ultra-High Thermoelectric Performance**

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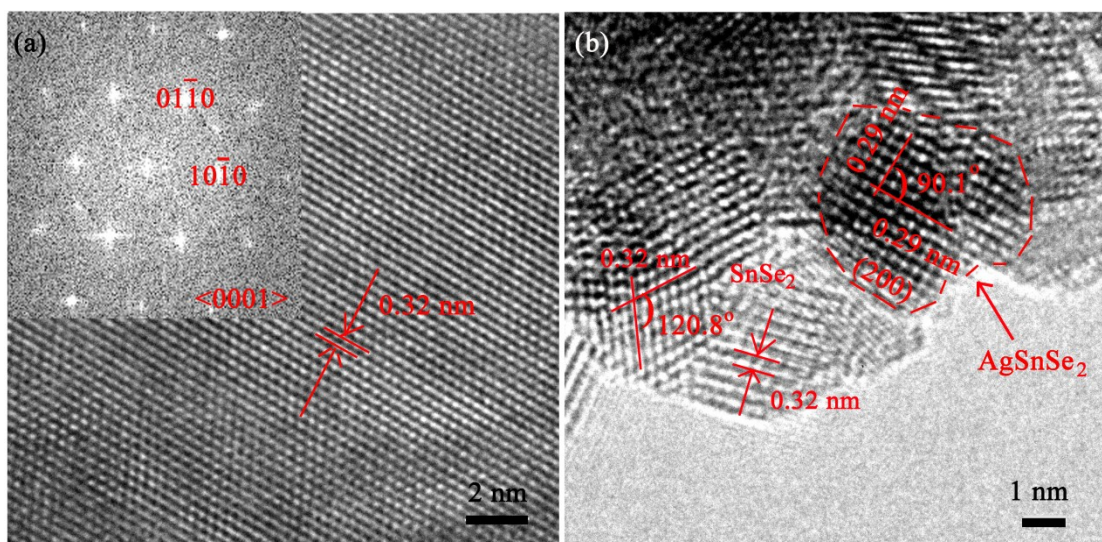


Fig. S1 Typical HRTEM images of the hydrothermal products with atomic (a) 0% and (b) 3% Ag-introduction. The inset in a is the corresponding FFT pattern.

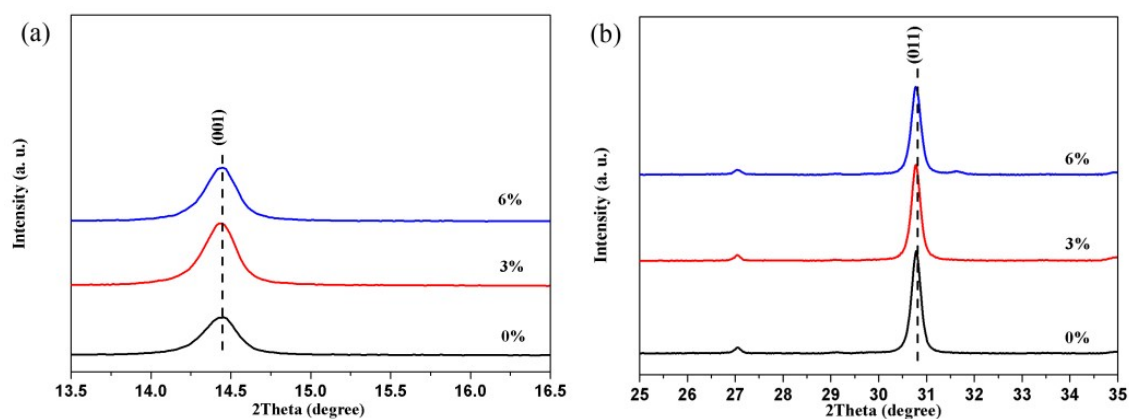


Fig. S2 Expanded view of XRD patterns in Fig. 1(b): (a) 13.5-16.5° and (b) 25-35°.

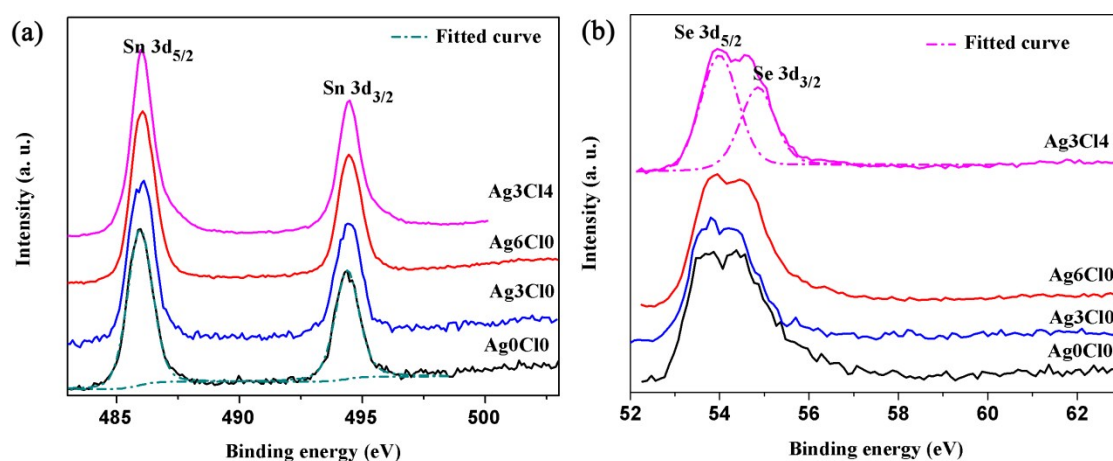


Fig. S3 High-resolution XPS of (a) Sn 3d and (b) Se 3d for the hot-pressed samples.

The binding energies of Sn 3d_{5/2} and Sn 3d_{3/2} are located at 494.4 eV and 485.9 eV (Fig. S3(a)),

respectively, suggesting that the chemical valence state of Sn is +4.¹ The high-resolution XPS spectrum of Se shows that the binding energies of Se $d_{5/2}$ and Se $3d_{3/2}$ are located at 54.1 eV and 55.2 eV, respectively, which may correspond to Se^{2-} bonded to Sn^{4+} .²

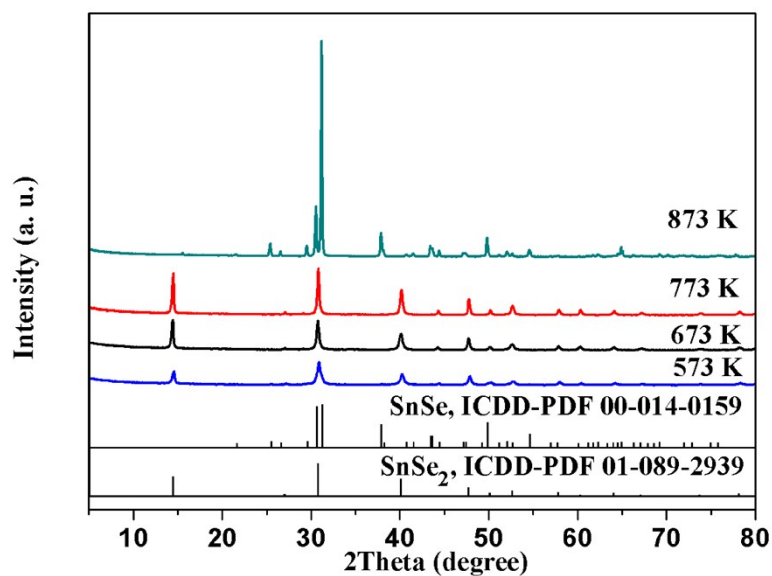


Fig. S4 XRD patterns of the sample Ag₀Cl₀ (grinded powders) after heat-treating process at different temperature.

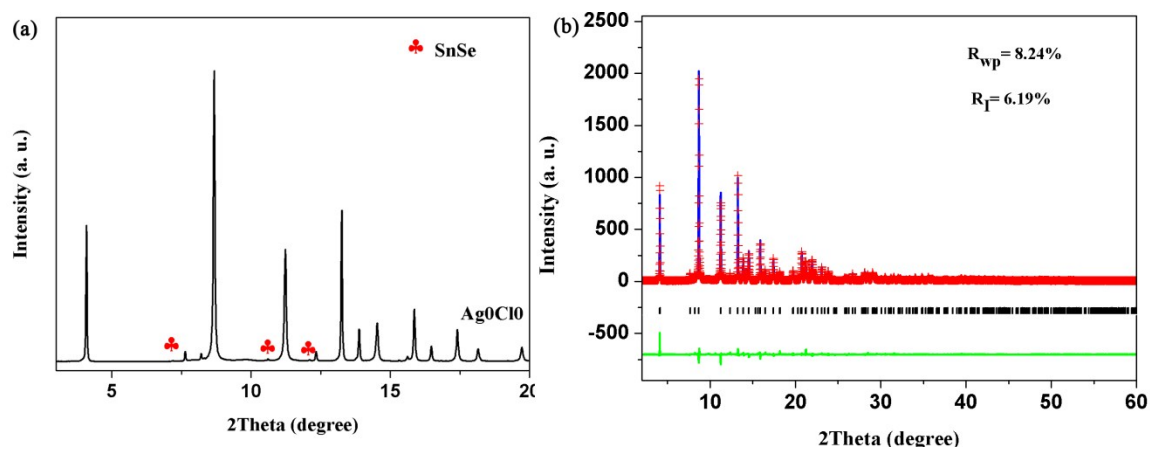


Fig. S5 (a) SR-XRD pattern of the sample Ag₀Cl₀ (grinded powders) after heat-treating process at 673 K. (b) The corresponding Rietveld refinement result with $R_{wp}=8.24\%$ and $R_I=6.19\%$.

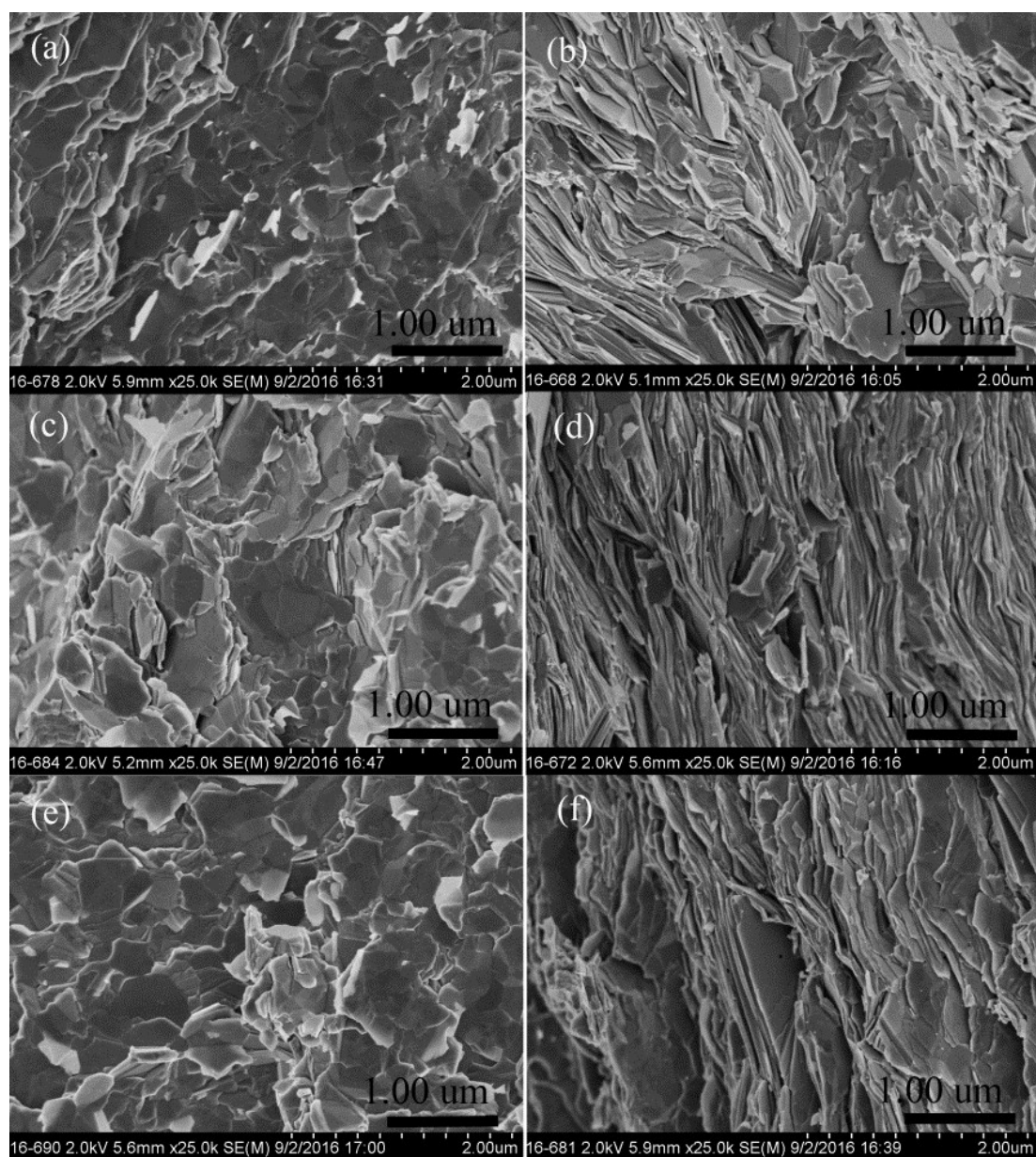


Fig. S6 Typical SEM images of the sample (a-b) Ag_0Cl_0 , (c-d) Ag_3Cl_0 and (e-f) Ag_3Cl_4 . The left side images were observed on the fracture surfaces perpendicular to the pressing direction while the right side ones were performed on the fracture surfaces parallel to the pressing direction.

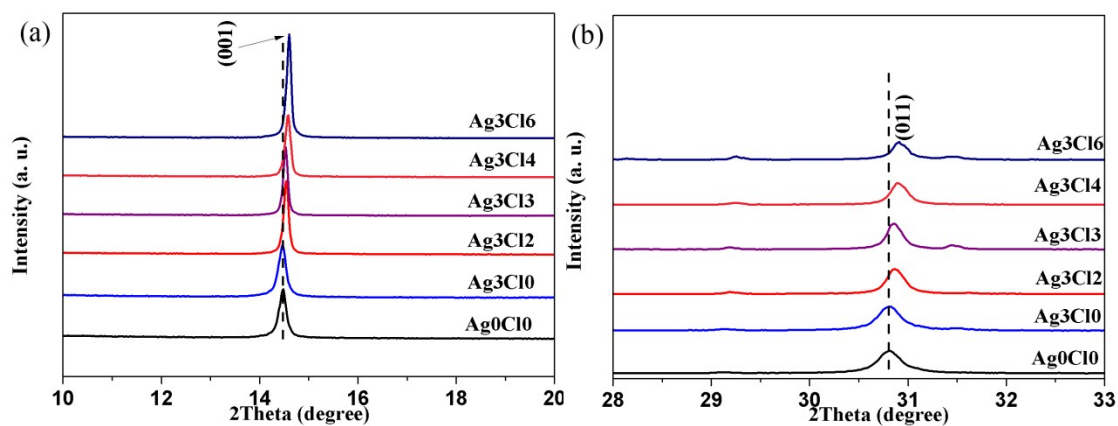


Fig. S7 Expanded view of XRD patterns in Fig. 2(b): (a) 10-20° and (b) 28-33°.

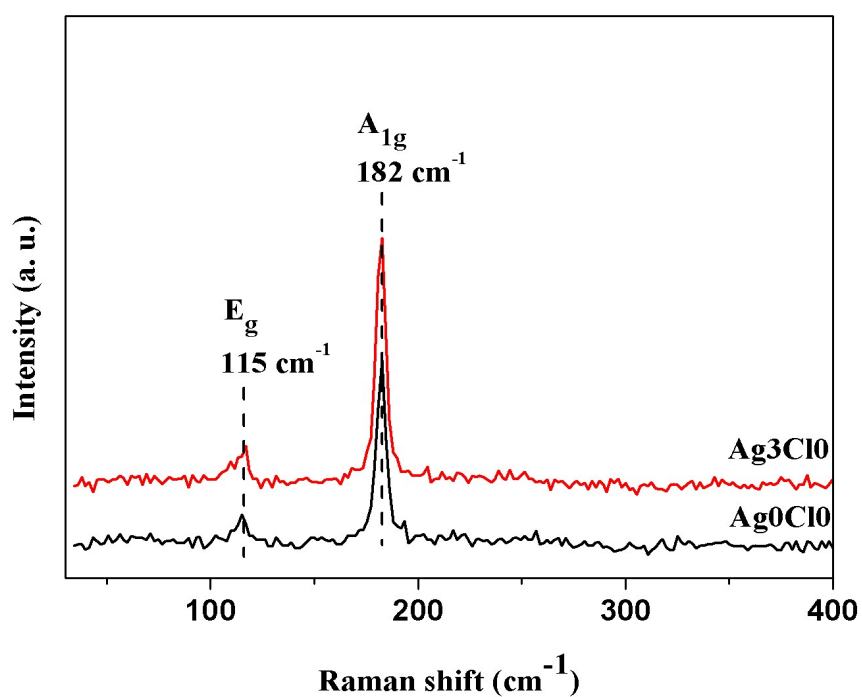


Fig. S8 Raman spectra of the sample Ag₀Cl₀ and Ag₃Cl₀.

The peaks at 115 cm⁻¹ and 182 cm⁻¹ (Fig. S9) can be attributed to the E_g mode (in plane vibration) and A_{1g} mode (out of plane vibration) of SnSe₂, respectively.^{1,3}

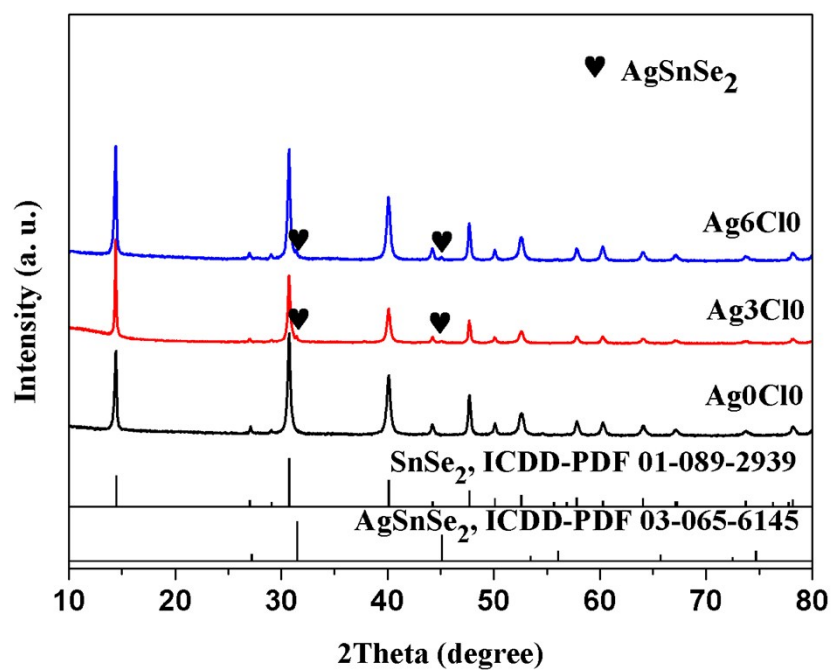


Fig. S9 XRD patterns of the sample Ag0Cl0, Ag3Cl0 and Ag6Cl0 (grinded powders)

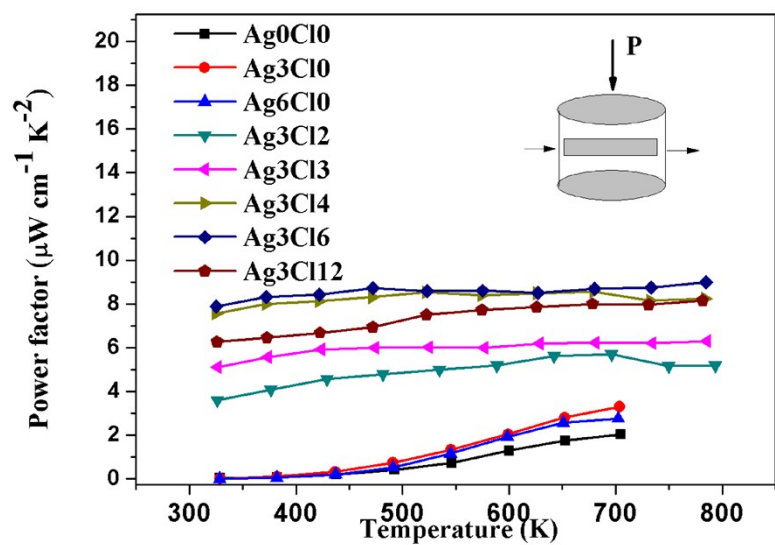


Fig. S10 Power factor of the hot-pressed samples perpendicular to the pressing direction.

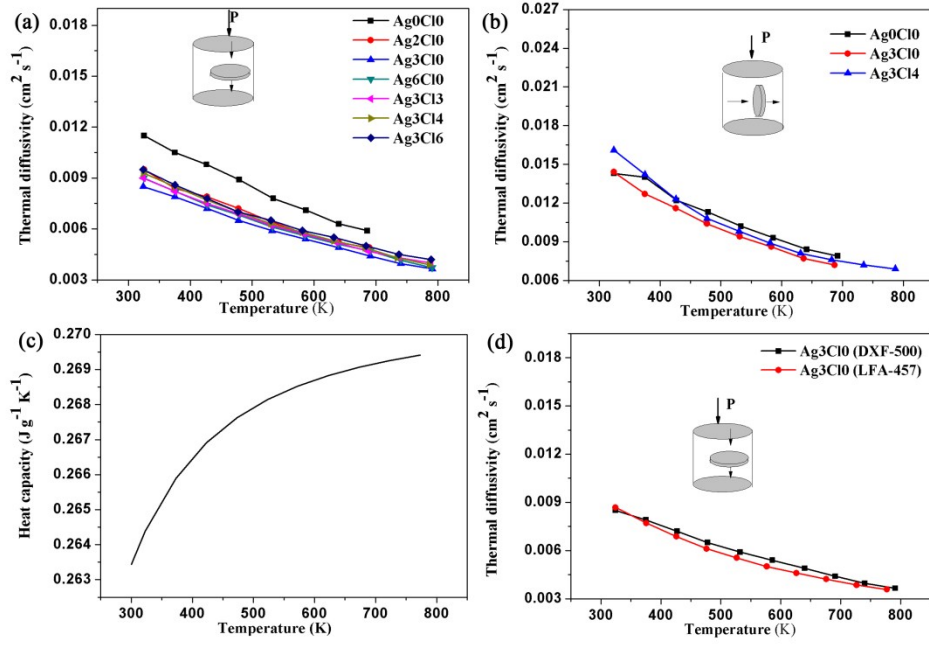


Fig. S11 Temperature-dependent thermal diffusivity (a) along the pressing direction, (b) perpendicular to the pressing direction and (c) heat capacity (Ag₃Cl₄). (d) The comparison of thermal diffusivity (Ag₃Cl₀) measured by the instrument DXF-500 and LFA-457.

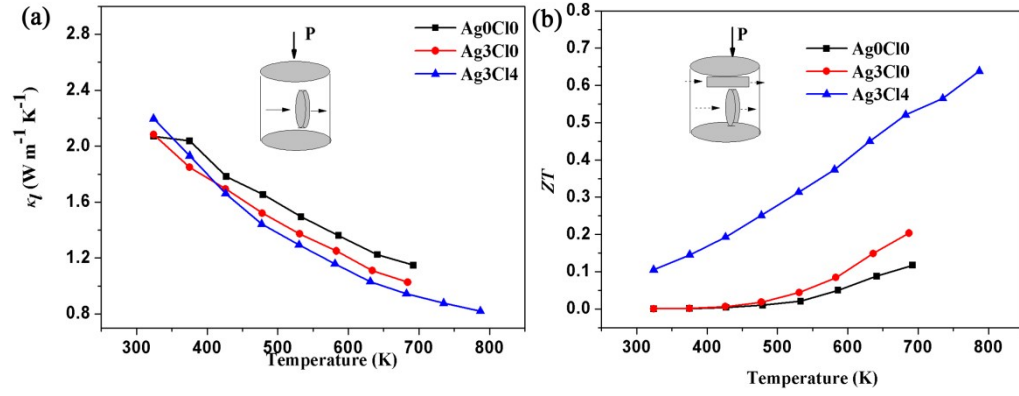


Fig. S12 (a) Lattice thermal conductivity and (b) ZT of the hot-pressed samples perpendicular to the pressing direction.

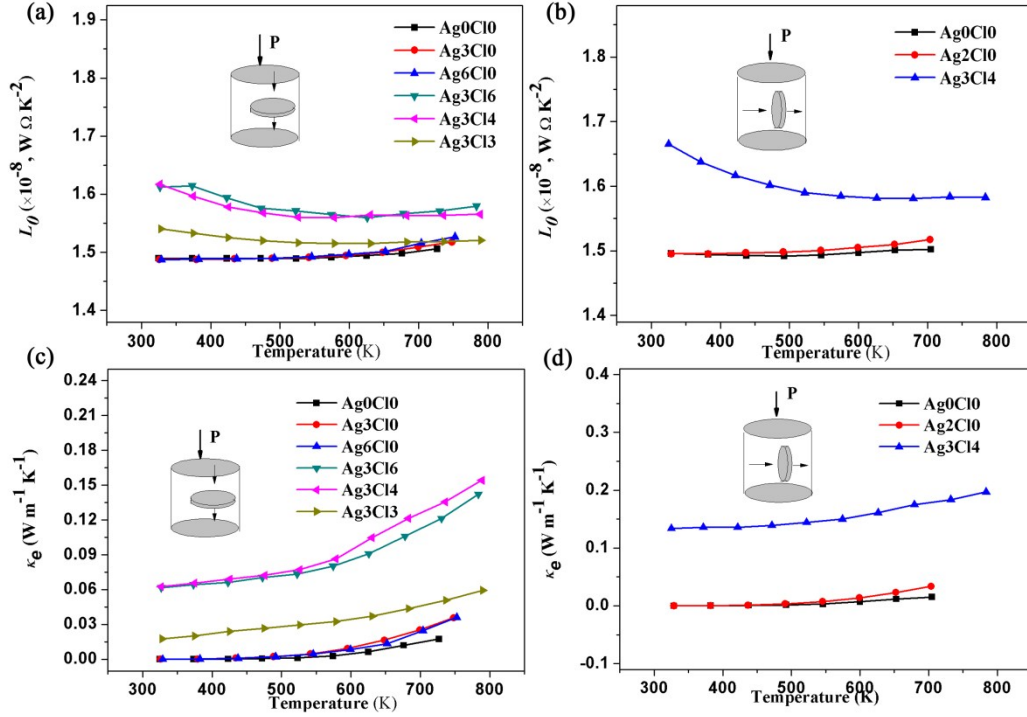


Fig. S13 Temperature-dependent Lorenz number (L_0) and electronic thermal conductivity (κ_e) of the hot-pressed samples (a, c) along and (b, d) perpendicular to the pressing direction.

The calculation of L_0

Assuming the acoustic phonon scattering dominates the carrier scattering mechanism, which indicates $r = -1/2$, the Lorenz number (L_0) can be estimated by the following equations

$$L_0 = \left(\frac{k_B}{e}\right)^2 \frac{3F_0(\eta)F_2(\eta) - 4F_1(\eta)^2}{F_0(\eta)^2} \quad (1)$$

$$S = \frac{k_B}{e} \left[\frac{2F_1(\eta)}{F_0(\eta)} - \eta \right] \quad (2)$$

$$F_n(\eta) = \int_0^{+\infty} x^n (e^{x-\eta} + 1)^{-1} dx \quad (3)$$

where k_B is the Boltzman constant, e is the electron charge, η is reduced Fermi energy $\eta = E_F/k_B T$,

$F_n(\eta)$ is the Fermi integration, which can be derived from the measured S on the basis of single band approximation.

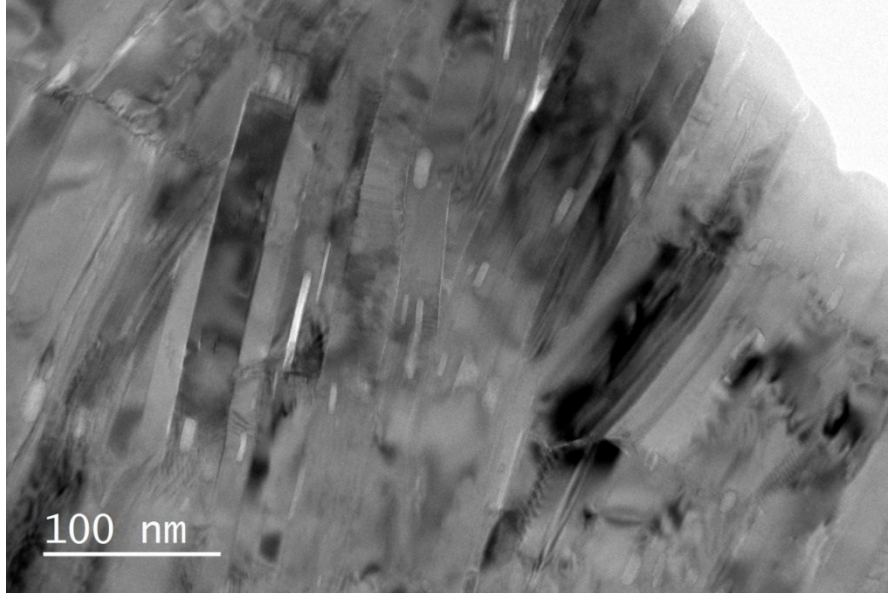


Fig. S14 A typical low-magnified TEM image of the sample Ag₃Cl₀.

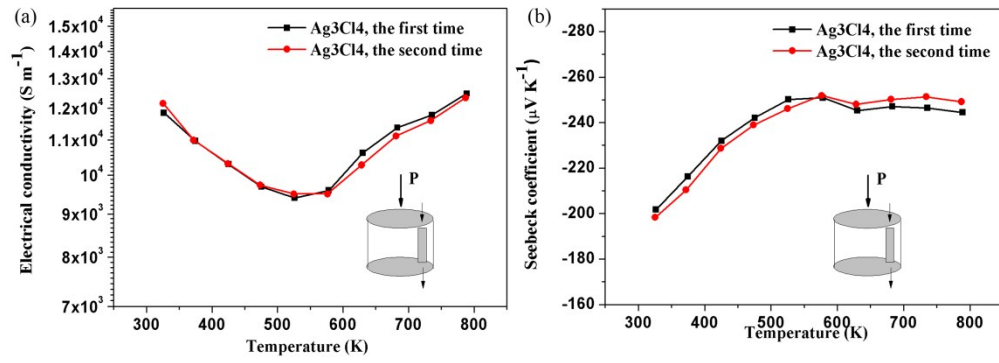


Fig. S15 (a) Electrical conductivity and (b) Seebeck coefficient of the sample Ag₃Cl₄ along the pressing direction collected by repeated heating measurement.

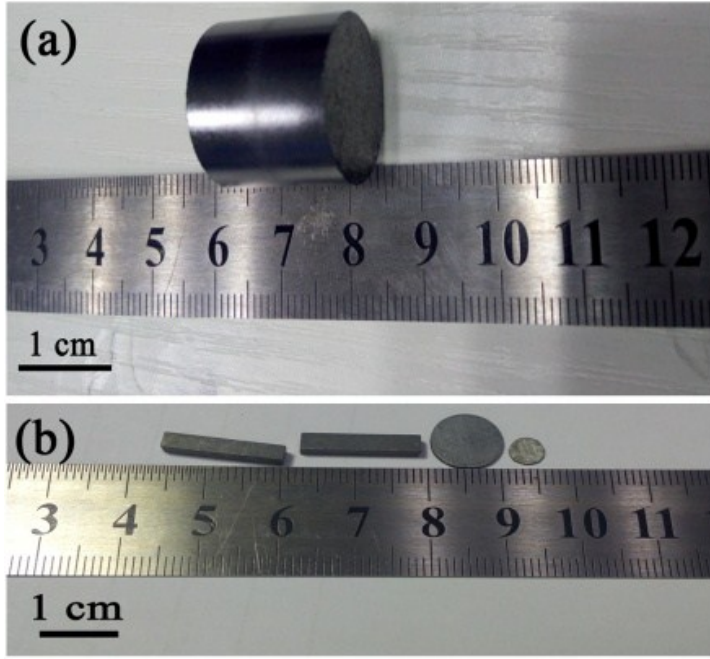


Fig. S16 Photographs of (a) a hot-pressed cylinder and (b) the corresponding cut and polished square bar and disks for the measurement of electrical and thermal transport, respectively.

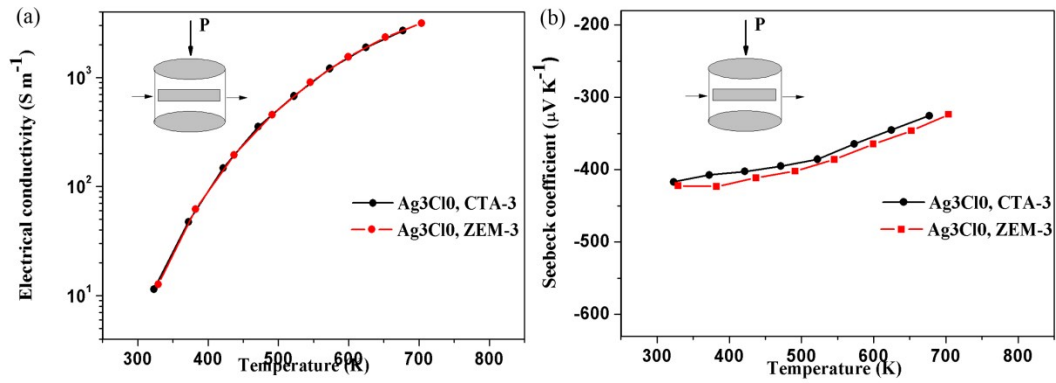


Fig. S17 Experimental data comparison of (a) electrical conductivity and (b) Seebeck coefficient between the instrument ZEM-3 and CTA-3 for the sample Ag_3ClO .

The Lotgering method

The orientation degree of the hot-pressed cylinders is calculated by the Lotgering method performed on the $(00l)$ crystal planes, which is termed as $F_{(00l)}$ and estimated by the following equations

$$F = \frac{P - P_0}{1 - P_0} \quad (4)$$

$$P_0 = \frac{I_0(00l)}{\sum I_0(hkl)} \quad (5)$$

$$P = \frac{I(00l)}{\sum I(hkl)} \quad (6)$$

where P_0 and P present the ratios of the integrated intensity of all (00 l) crystal planes to those of all the (hkl) crystal planes. In the present work, the P_0 and P are calculated by using the standard PDF card (JCPDS no. 01-89-2939) and the XRD data shown in Figure 2a, respectively. The results are given in Table SI.

Table S1. The orientation degree of the hot-pressed samples.

Samples	$P_{(00l)}$	$F_{(00l)}$
Ag0Cl0	0.37	0.21
Ag3Cl0	0.44	0.29
Ag3Cl2	0.40	0.24
Ag3Cl3	0.44	0.29
Ag3Cl4	0.42	0.27
Ag3Cl6	0.55	0.43

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